



No.3568

2SK1430

## N-Channel MOS Silicon FET

## Very High-Speed Switching Applications

## Features

- Low ON-state resistance.
  - Very high-speed switching.
  - Converters.
  - Micaless package facilitating easy mounting.

### Absolute Maximum Ratings at Ta = 25°C

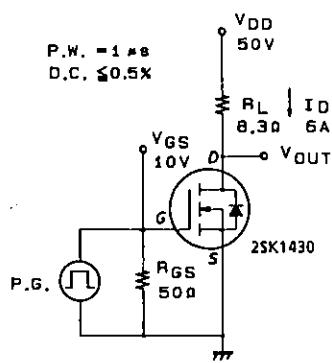
		Unit
Drain to Source Voltage	V <sub>DSS</sub>	100 V
Gate to Source Voltage	V <sub>GSS</sub>	±20 V
Drain Current(DC)	I <sub>D</sub>	10 A
Drain Current(Pulse)	I <sub>DP</sub>	PW ≤ 10 μs, duty cycle ≤ 1% 40 A
Allowable Power Dissipation	P <sub>D</sub>	T <sub>c</sub> = 25°C 25 W 2.0 W
Channel Temperature	T <sub>ch</sub>	150 °C
Storage Temperature	T <sub>stg</sub>	-55 to +150 °C

### Electrical Characteristics at Ta = 25°C

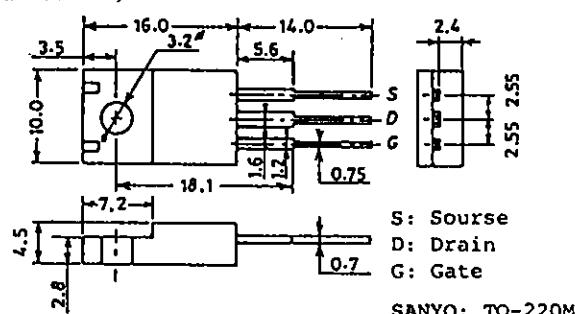
			min	typ	max	unit
D-S Breakdown Voltage	$V_{(BR)DSS}$	$I_D = 1\text{mA}, V_{GS} = 0$	100			V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 100\text{V}, V_{GS} = 0$		100		$\mu\text{A}$
Gate to Source Leakage Current	$I_{GSS}$	$V_{GS} = \pm 20\text{V}, V_{DS} = 0$			$\pm 100$	nA
Cutoff Voltage	$V_{GS(\text{off})}$	$V_{DS} = 10\text{V}, I_D = 1\text{mA}$	1.5		2.5	V
Forward Transfer Admittance	$ Y_{fs} $	$V_{DS} = 10\text{V}, I_D = 6\text{A}$	5.0	8.0		S
Static Drain to Source on State Resistance	$R_{DS(\text{on})}$	$I_D = 6\text{A}, V_{GS} = 10\text{V}$		0.12	0.16	$\Omega$
Input Capacitance	$C_{iss}$	$V_{DS} = 20\text{V}, f = 1\text{MHz}$	750			pF
Output Capacitance	$C_{oss}$	$V_{DS} = 20\text{V}, f = 1\text{MHz}$	230			pF
Reverse Transfer Capacitance	$C_{rss}$	$V_{DS} = 20\text{V}, f = 1\text{MHz}$	70			pF
Turn-ON Delay Time	$t_{d(on)}$			12		ns
Rise Time	$t_r$	$I_D = 6\text{A}, V_{GS} = 10\text{V}$		38		ns
Turn-OFF Delay Time	$t_{d(off)}$	$V_{DD} = 50\text{V}, R_{GS} = 50\Omega$		100		ns
Fall Time	$t_f$			40		ns
Diode Forward Voltage	$V_{SD}$	$I_S = 10\text{A}, V_{GS} = 0$		1.8		V

(Note) Be careful in handling the 2SK1430 because it has no protection diode between gate and source.

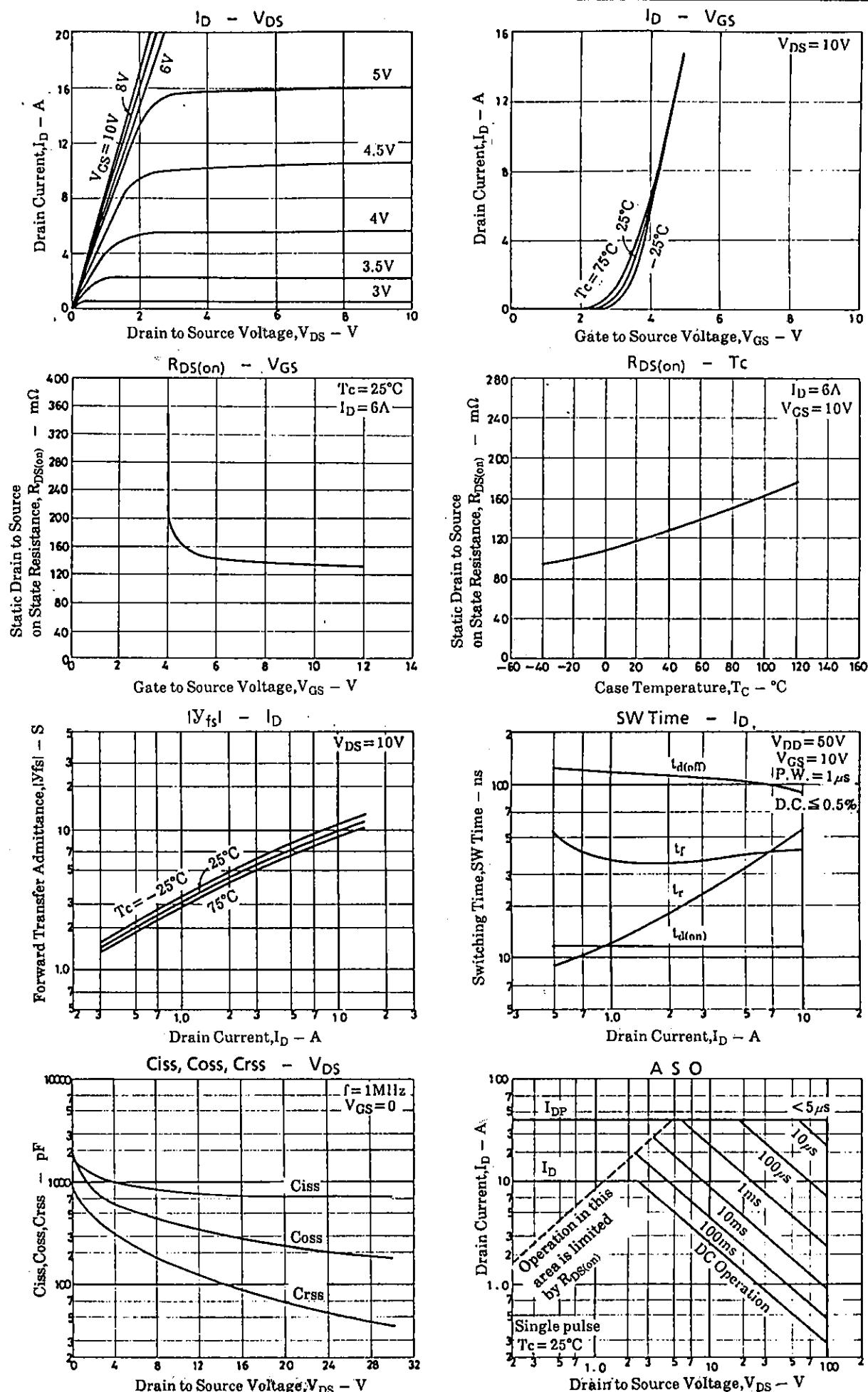
## Switching Time Test Circuit

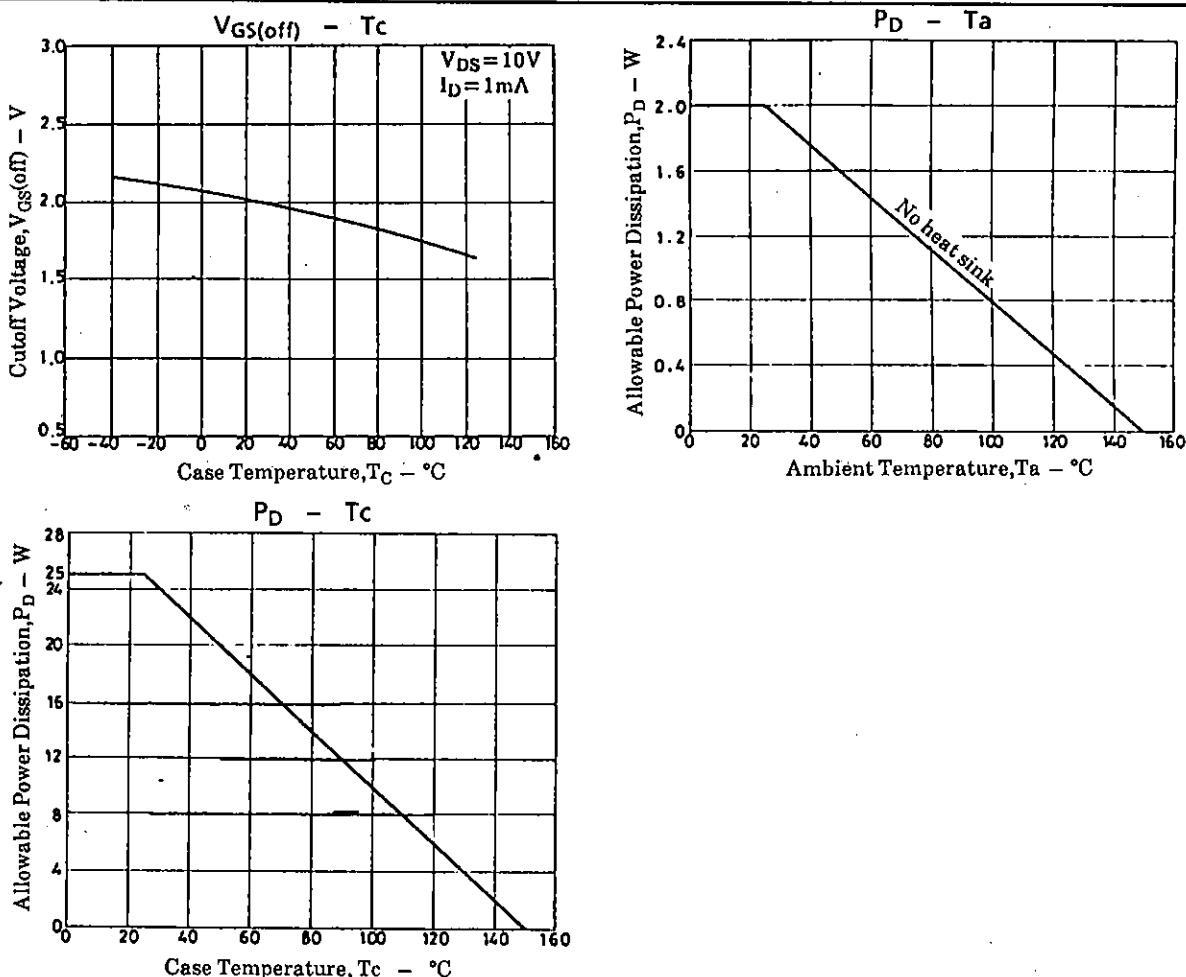


### **Package Dimensions 2063**



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